

### **Description**

The AON7410 uses advanced trench

technology to provide excellent R<sub>DS(ON)</sub>, low gate

charge and operation with gate voltages as low

as 4.5V. This device is suitable for use as a

Battery protection or in other Switching application.

#### **General Features**

 $V_{DS} = 30V I_{D} = 30 A$ 

 $R_{DS(ON)}$  < 13m $\Omega$  @  $V_{GS}$ =10V

### **Application**

Battery protection

Load switch

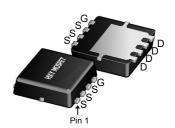
Uninterruptible power supply

# Package Marking and Ordering Information

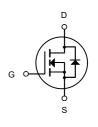
Product ID	Pack	Brand	Qty(PCS)
AON7410	DFN3X3-8L	HXY MOSFET	5000

### Absolute Maximum Ratings (T<sub>C</sub>=25 ℃ unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	30	V
VGS	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	30	А
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	18	Α
IDM	Pulsed Drain Current <sup>2</sup>	55	Α
EAS	Single Pulse Avalanche Energy <sup>3</sup>	22.1	mJ
IAS	Avalanche Current	21	Α
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	20	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
ReJA	Thermal Resistance Junction-ambient <sup>1</sup>	75	°C/W
R <sub>θ</sub> JC	Thermal Resistance Junction-Case <sup>1</sup>	6	°C/W



DFN3X3-8L



N-Channel MOSFET



# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
△BVpss/△TJ	BVDSS Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.022		V/°C
Rds(on)	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =10A		8	13	
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =5A		12	20	mΩ
V <sub>G</sub> S(th)	Gate Threshold Voltage		1.0		2.5	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_D=250uA$		-5.1		mV/°C
	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	
IDSS		V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	uA
Igss	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =1A		4.5		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2.5		Ω
Qg	Total Gate Charge (4.5V)	V <sub>DS</sub> =20V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =10A		7.2		nC
Qgs	Gate-Source Charge			1.4		
Qgd	Gate-Drain Charge			2.2		
T <sub>d</sub> (on)	Turn-On Delay Time	V <sub>DD</sub> =12V , V <sub>GS</sub> =10V , R <sub>G</sub> =3.3 I <sub>D</sub> =5A		4.1		
Tr	Rise Time			9.8		
T <sub>d</sub> (off)	Turn-Off Delay Time			15.5		ns
T <sub>f</sub>	Fall Time			6.0		
Ciss	Input Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		572		
Coss	Output Capacitance			81		pF
Crss	Reverse Transfer Capacitance			65		
ls	Continuous Source Current <sup>1,5</sup>	\/ =\/ =0\/ Force Current			28	Α
Іѕм	Pulsed Source Current <sup>2,5</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			55	Α
VsD	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1.2	V

#### Note:

<sup>1.</sup>The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

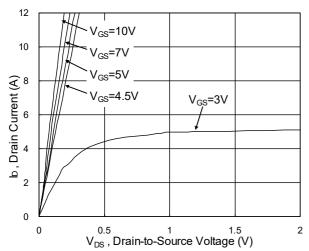
<sup>2.</sup>The data tested by pulsed , pulse width  $\leq 300 us$  , duty cycle  $\leq 2\%$ 

<sup>3.</sup> The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V, $V_{GS}$ =10V,L=0.1mH, $I_{AS}$ =21A

<sup>4 .</sup>The power dissipation is limited by 150  $^{\circ}$ C junction temperature 5.The data is theoretically the same as  $I_{D}$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

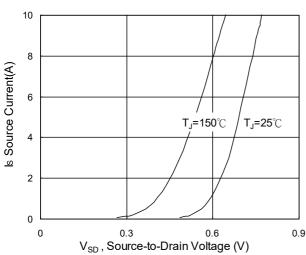


Fig.3 Forward Characteristics Of Reverse

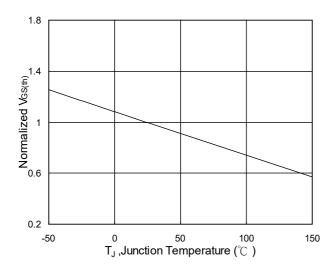


Fig.5 Normalized  $V_{\text{GS(th)}}$  vs.  $T_{\text{J}}$ 

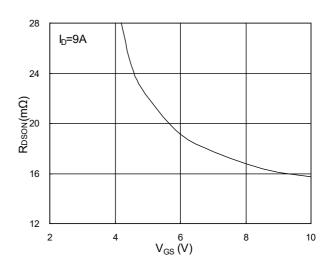


Fig.2 On-Resistance vs. Gate-Source

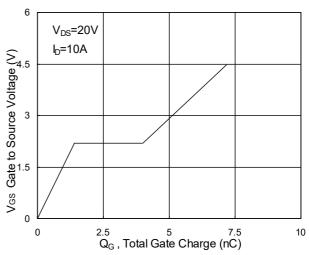


Fig.4 Gate-Charge Characteristics

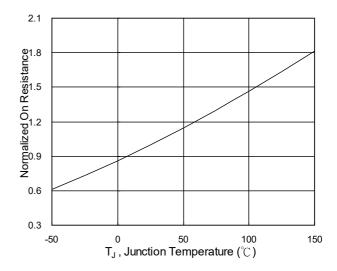
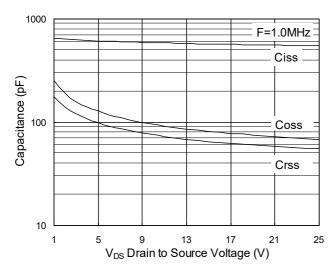


Fig.6 Normalized R<sub>DSON</sub> vs T<sub>J</sub>



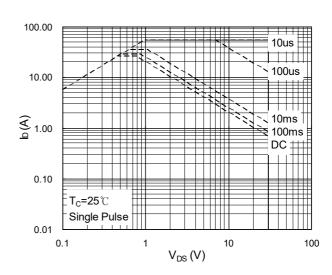


Fig.7 Capacitance

Fig.8 Safe Operating Area

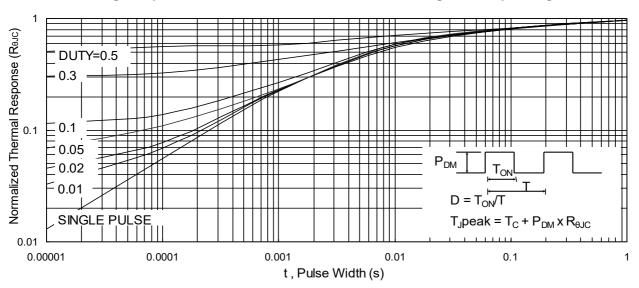


Fig.9 Normalized Maximum Transient Thermal Impedance

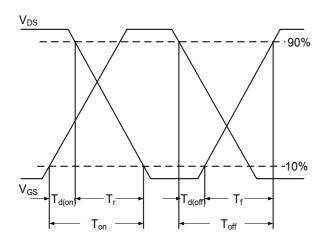


Fig.10 Switching Time Waveform

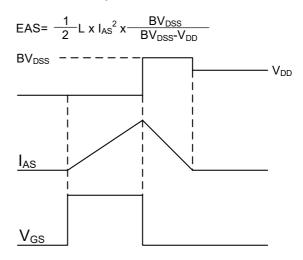
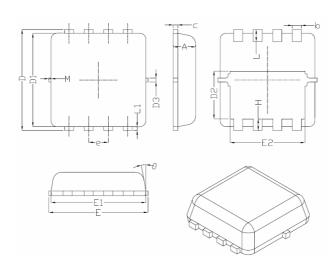


Fig.11 Unclamped Inductive Waveform



# **DFN3X3-8L Package Information**



Symbol	Dimensions In Millimeters			
	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
M	*	*	0.15	
θ		10°	12 <sup>°</sup>	



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